

Title (en)
BLISTER PACKAGING COMPONENTS

Title (de)
BESTANDTEILE EINER BLISTERPACKUNG

Title (fr)
ÉLÉMENTS EMBALLAGE-COQUE

Publication
EP 3152053 A1 20170412 (EN)

Application
EP 14895844 A 20140606

Priority
US 2014041260 W 20140606

Abstract (en)
[origin: WO2015199637A1] The present invention relates to blister components for blister packages formed from multilayer thermoplastic films. In one embodiment of the present invention, the thermoformed blister component comprises a first exterior layer of polyvinylchloride (PVC) or polyvinylidene chloride; one interior layer comprising a blend of a high density polyethylene, high density polyethylene nucleation additive and optionally, a hydrocarbon resin, or a high density polyethylene and has a thickness of between 50 m to 254 m (2 mil to 10 mil); and a second exterior layer comprising a material selected from the group consisting of polyvinylchloride, polyvinylidene chloride, cyclic olefin copolymer, polypropylene, high impact polystyrene, general purpose polystyrene, styrene block copolymer, polyethylene terephthalate, oriented polyethylene terephthalate, amorphous polyethylene terephthalate, glycol-modified polyethylene terephthalate and polylactic acid.

IPC 8 full level
B32B 27/00 (2006.01); **B65D 83/04** (2006.01)

CPC (source: EP)
B32B 7/12 (2013.01); **B32B 27/08** (2013.01); **B32B 27/302** (2013.01); **B32B 27/304** (2013.01); **B32B 27/32** (2013.01); **B32B 27/327** (2013.01);
B32B 27/36 (2013.01); **B65D 75/327** (2013.01); **B32B 2250/24** (2013.01); **B32B 2250/40** (2013.01); **B32B 2270/00** (2013.01);
B32B 2307/558 (2013.01); **B32B 2307/704** (2013.01); **B32B 2307/7246** (2013.01); **B32B 2439/40** (2013.01); **B32B 2439/80** (2013.01);
Y02W 90/10 (2015.05)

Designated contracting state (EPC)
AL AT BE BG CH CY CZ DE DK EE ES FI FR GB GR HR HU IE IS IT LI LT LU LV MC MK MT NL NO PL PT RO RS SE SI SK SM TR

Designated extension state (EPC)
BA ME

DOCDB simple family (publication)
WO 2015199637 A1 20151230; EP 3152053 A1 20170412; EP 3152053 A4 20180214

DOCDB simple family (application)
US 2014041260 W 20140606; EP 14895844 A 20140606